



ZXCT210

#### 26V, ZERO-DRIFT, HIGH PRECISION CURRENT MONITOR

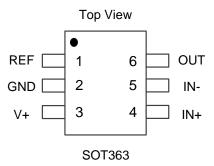
#### **Description**

The DIODES™ ZXCT210 is a high precision current-shunt monitor with gain 200V/V to measure low voltage drop (10mV) across a small shunt resistor with minimal error. This enables high accuracy of large current measurement and reduces a power loss caused by the measurement. OUT pin is a voltage proportional to the load current. It can then be processed with an ADC.

This device is designed with zero-drift architecture and is manufactured by post trim technology to achieve low offset voltage ( $\pm 30\mu V$ ), low gain drift (10ppm/°C) and low gain error ( $\pm 0.5\%$ ) among full temperature range for precise measurement.

The ZXCT210 operates from a single 2.7V to 26V power supply with a maximum of  $100\mu A$  of supply current from -40°C to +125°C, and is offered in SOT363 package.

#### **Pin Assignments**



#### **Features**

- Supply Voltage Range: 2.7V to 26V
- Temperature Range: -40°C to +125°C
- Wide Common-Mode Range: -0.1V to 26V
- Support Shunt Drops of 10mV Full-Scale
- Gain Error (Maximum Overtemperature)
  - A and B Version: ±0.8%
  - C Version: ±0.5%
- Offset Voltage (Maximum Overemperature)
  - A Version: ±35µV
  - B and C Version: ±30µV
- 0.5µV/°C Offset Drift (Maximum)
- 10ppm/°C Gain Drift (Maximum)
- Quiescent Current: 100µA (Maximum)
- Rail-to-Rail Output Capacity
- Gains: 200V/V
- Package: 6-Pin SOT363
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>

#### **Applications**

- Current sensing (high-side/low-side)
- Battery charging and discharging
- Computer racks
- High performance video cards
- Industrials
- Power supplies
- Instrumentation
- Control systems
- Metering

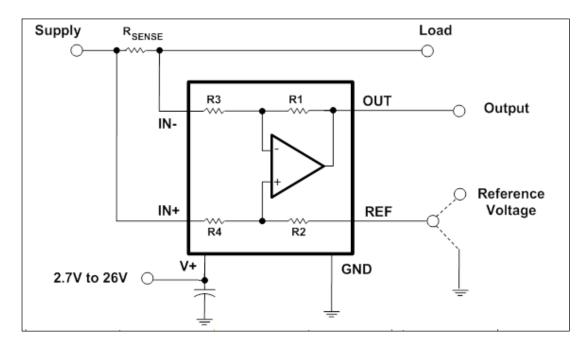
Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



# **Typical Applications Circuit**

Part Number	Version	Gain	Gain Error	V <sub>os</sub>	Gain Drift
Fait Number	Version	V/V	%	μV	ppm/°C
ZXCT210A	Α	200	0.8	±35	10
ZXCT210B	В	200	0.8	±30	10
ZXCT210C	С	200	0.5	±30	10



 $V_{OUT} = (I_{LOAD} \times R_{SENSE}) GAIN + V_{REF}$ 

### **Pin Descriptions**

Pin Name	Pin Number SOT363	1/0	Description
REF	1	Analog input	Reference voltage, 0V to V+
GND	2	_	Ground
V+	3	Power	Power supply, 2.7V to 26V
IN+	4	Analog input	Connect to supply side of shunt resistor.
IN-	5	Analog input	Connect to load side of shunt resistor.
OUT	6	Analog output	Output voltage



### Absolute Maximum Ratings (@ TA = +25°C, unless otherwise specified.) (Note 4)

Description		Rating	Unit
Supply Volatge (V+)		+26	V
Analog Innuta INI INI	Differential (IN+)-(IN-)	-26 to 26	V
Analog Inputs IN+, IN-	Common Mode	GND - 0.3 to 26	V
REF Input Voltage		GND - 0.3 to (V+) + 0.3	V
Output		GND - 0.3 to (V+) + 0.3	V
Input Current into All Pins (Note 5)		5	mA
ESD Human Body ESD Protection (HBM)		±5	kV
ESD Charged-Device Model ESD Protection (CDM)		±1.5	kV

Notes:

#### Thermal Information (Note 6)

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance	228	°C/W
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	64	C/VV

Note:

6.  $R_{\theta JA}$  and  $R_{\theta JC}$  are measured at  $T_A$  = +25°C on a high effective thermal conductivity four-layer test board per JEDEC 51-7.

#### **Recommended Operating Conditions** (Note 7)

Symbol	Parameter	Min	Тур	Max	Unit
Vсм	Common-Mode Input Voltage	-0.1	12	26	V
Vs	Operating Supply Voltage (Applied to V+)	2.7	5	26	V
TA	Operating Ambient Temperature	-40	_	+125	°C

Note:

7. Refer to the Typical Application Circuit.

<sup>4.</sup> Stresses greater than those listed under *Absolute Maximum Ratings* can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to *Absolute Maximum Ratings* for extended periods can affect device reliability.

<sup>5.</sup> Input voltage at any pin can exceed the voltage shown if the current at that pin is limited to 5mA.



### **Electrical Characteristics** (TA = +25°C, VS = 5V, VIN+ = 12V, VSENSE = VIN+ - VIN-, and VREF = VS/2, unless otherwise noted.)

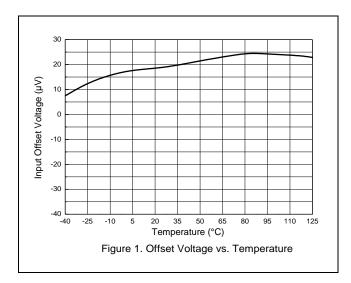
Symbol	Para	ameter	Test Conditions	Min	Тур	Max	Unit
Vсм	Common-Mode Input		T <sub>A</sub> = -40°C to +125°C	-0.3	_	26	VV
CMRR	Common-Mode Rejection		ZXCT210, V <sub>IN+</sub> = 0V to 26V V <sub>SENSE</sub> = 0mV T <sub>A</sub> = -40°C to +125°C	100	120	_	dB
V <sub>os</sub>	Offset Voltage, RTI	(Note 8)	ZXCT210A, V <sub>SENSE</sub> = 0mV	_	±0.55	±35	μV
• 05	Onset Vollage, KTT	(14010-0)	ZXCT210B, ZXCT210C V <sub>SENSE</sub> = 0mV	_	±0.55	±30	μV
dVos/dT	Vos vs. Temperatur	е	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$	_	0.1	0.5	μV/°C
_	Long-Term Stability	(Note 9)	_		_	100	μV
PSRR	Power Supply Reject	etion	$V_S = 2.7V \text{ to } 18V$ $V_{IN+} = 18V, V_{SENSE} = 0mV$		±0.1		μV/V
IΒ	Input Bias Current		V <sub>SENSE</sub> = 0mV	-	28	-	μΑ
I <sub>OS</sub>	Input Offset Current		V <sub>SENSE</sub> = 0mV		±0.02		μΑ
G	Gain	ZXCT210	_	1	_	-	V/V
E <sub>G</sub>	Gain Error		A and B Version, $V_{SENSE} = -5mV$ to $5mV$ $T_A = -40$ °C to $+125$ °C		±0.03%	±0.8%	_
EG	Gain Life		C Version, VSENSE = -5mV to 5mV $T_A = -40$ °C to +125°C	1	±0.03%	±0.5%	_
_	Gain Drift vs. Temperature		T <sub>A</sub> = -40°C to +125°C		3	10	ppm/°C
_	Nonlinearity Error		Vsense = -5mV to 5mV	_	±0.01%	_	_
V <sub>OH</sub>	Swing to V+ Power-	Supply Rail	$R_L = 10k\Omega$ to GND, $T_A = -40$ °C to $+125$ °C	_	(V+) - 0.05	(V+) – 0.2	V
V <sub>OL</sub>	Swing to GND		$R_L = 10k\Omega$ to GND, $T_A = -40^{\circ}C$ to $+125^{\circ}C$	_	(V <sub>GND</sub> ) + 0.005	(V <sub>GND</sub> ) + 0.05	V
_	Maximum Capacitive	e Load	No Sustained Oscillation	_	1	_	nF
GBW	Band Width		CLOAD = 10pF, ZXCT210	_	14	_	kHz
SR	Slew Rate		_		0.4		V/µs
_	Voltage Noise Density		_	1	25		nV/√Hz
Va	Vs Operating Voltage Range		T <sub>A</sub> = -40°C to +125°C	2.7	_	26	V
VS			-20°C to +85°C	2.5	_	26	V
	I <sub>Q</sub> Quiescent Current		V <sub>SENSE</sub> = 0mV	_	65	100	μΑ
IQ			$T_A = -40^{\circ}\text{C to } +125^{\circ}\text{C}$	_	_	115	μΑ
TJ	Operating Junction	Temperature	_	-40	_	+150	°C
Tstg	Storage Temperatur	re Range	_	-65	_	+150	°C

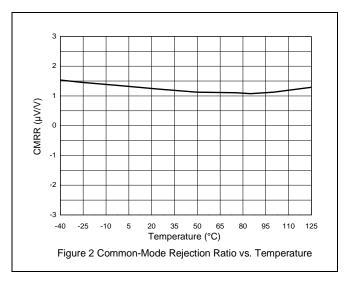
Notes:

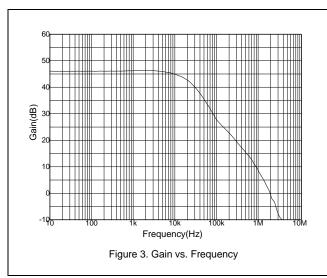
<sup>8.</sup> RTI = Referred to input.
9. The long-term stability is defined as MAX. V<sub>OS</sub> shift during high temperature life test 1000 hours with T<sub>A</sub> = +125°C. This V<sub>OS</sub> drift with time is not a linear function of time, and the shift is greater initially and diminishes over time. This parameter is guaranteed by design.

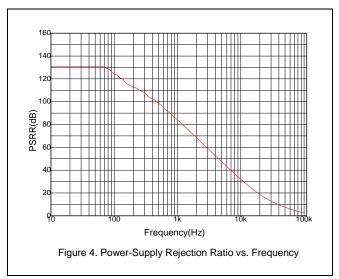


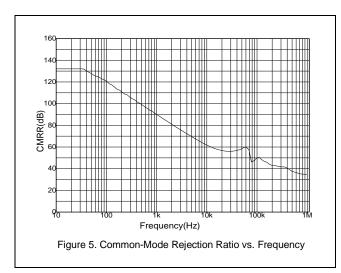
### **Typical Performance Characteristics**

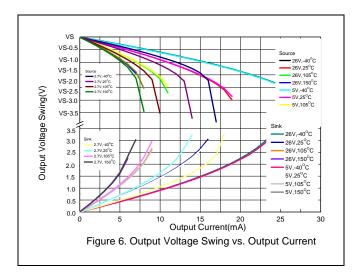






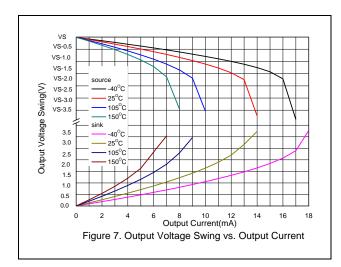


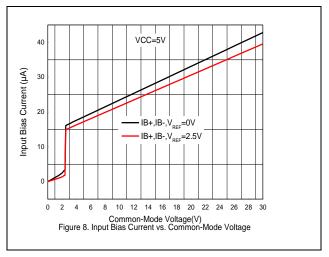


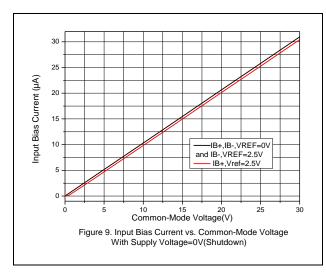


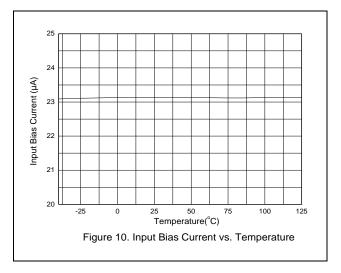


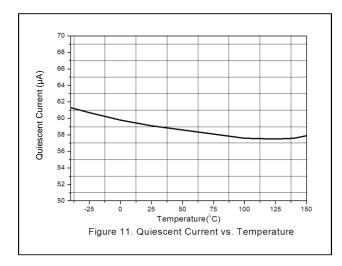
## **Typical Performance Characteristics** (continued)

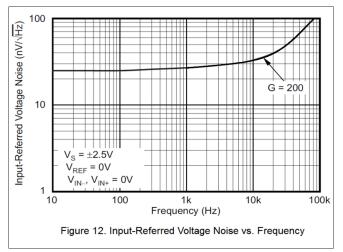






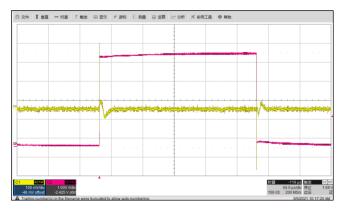








# Typical Performance Characteristics (continued)



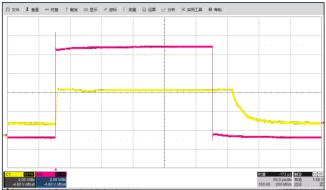
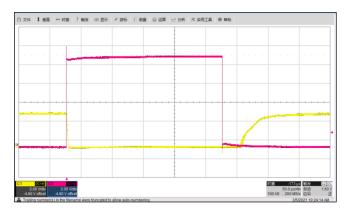


Figure 13. Common-Mode Voltage vs. Transient Response

Figure 14. Noninverting Differential Input Overload



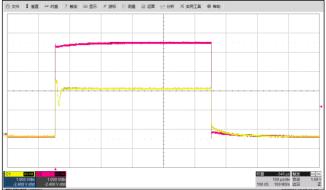
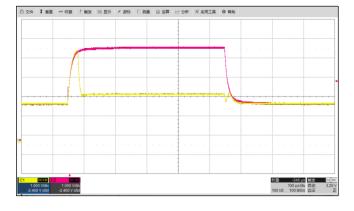


Figure 15. Inverting Differential Input Overload

Figure 16. Start-up Response



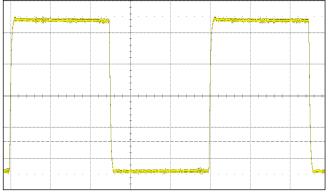


Figure 17. Brownout Recovery

Figure 18. Output Stability with Load 2.2nF



### **Application Information**

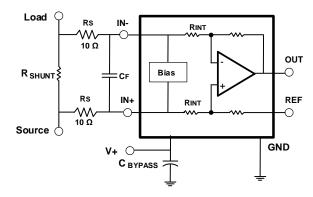


Figure 19. Filter at Input Pins

#### Input Filtering

Input filtering may be needed to limit the bandwidth of signals or to add protection against transients that may be generated as the result of shunt inductance. If the added source resistors are not closely matched there is an adverse impact on gain error, CMRR and Vos. Figure 19 shows a filter placed at the inputs pins. It is recommended the added input resistors (Rs) should be  $10\Omega$  or less.

As a consideration to mitigate the impact of shunt inductance in a high current, high transient environment the RC time constant of the added  $R_S$  and  $C_F$  should be greater than the time constant implied by the inductance and resistance implied by  $R_{SHUNT}$ .

$$2 \cdot R_S \cdot C_F \geq \frac{L_{SHUNT}}{R_{SHUNT}}$$

Due to additional current used in the bias circuit the voltage between the IN- and IN+ pins will differ from voltage across the sense resistor. This will appear as a gain error at the output. These internal bias currents from the inputs are not equal in magnitude and change depending on common mode conditions. This is the motivation of keeping the added resistor below  $10\Omega$ . The chart below has the equations for calculating the gain errors based on adding well matched source resistors. The equations include a provision for the additional  $20\mu$ A current used by the bias circuit block that is depicted as bias in Figure 19.

Product	Gain	R <sub>INT</sub>	Gain Error		Gain Error % *	
Floudet	Gain	R3 and R4	3 and R4 Factor Equations	Rs = 10Ω	R <sub>S</sub> = 20Ω	$R_S = 30\Omega$
ZXCT210	200	5kΩ	$\frac{1,000}{R_S + 1000}$	0.9901%	1.9608%	2.9220%

<sup>\*</sup>The percentages shown should be rounded to 2 significant figures. The excess can be used to check calculations. This is for a typical semiconductor process.

 $Gain Error (\%) = 100 \cdot (1 - Gain Error Factor)$ 

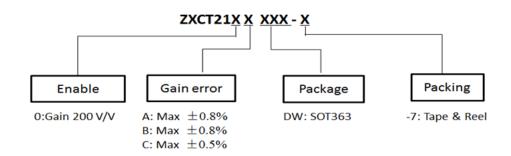
Where

R<sub>INT</sub> is the internal resistors R3 and R4 used to set the gain and differs per device type.

Rs is the added input resistors.



### **Ordering Information**



Part Number	Suffix	Package Code Pa	Package Code Package	Packing		
Fait Number	Sullix			Fackage	Qty.	Carrier
ZXCT210ADW-7	-7	DW	SOT363	3000	7" Tape and Reel	
ZXCT210BDW-7	-7	DW	SOT363	3000	7" Tape and Reel	
ZXCT210CDW-7	-7	DW	SOT363	3000	7" Tape and Reel	

#### **Marking Information**

#### **SOT363**

#### (Top View)

6 5 4 2

XX: Identification Code  $\underline{Y}$ : Year (ex: 2 = 2022)

<u>W</u>: Week: A to Z: week 1 to 26; a to z: week 27 to 52; z represents week 52 and 53

X: Internal Code

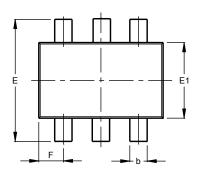
Part Number	Package	Identification Code
ZXCT210ADW-7	SOT363	YC
ZXCT210BDW-7	SOT363	YD
ZXCT210CDW-7	SOT363	YE

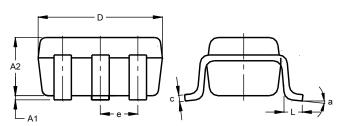


### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT363**



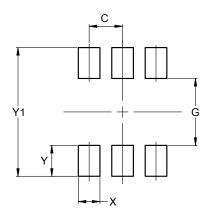


	SOT363					
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.10	0.30	0.25			
C	0.10	0.22	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
F	0.40	0.45	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All Dimensions in mm						

### **Suggested PAD Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT363**



Dimensions	Value
Difficitions	(in mm)
С	0.650
G	1.300
Х	0.420
Υ	0.600
Y1	2.500

#### **Mechanical Data**

#### **SOT363**

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.006 grams (Approximate)
- Max Soldering Temperature +260°C for 30 secs as per JEDEC J-STD-020



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